R07DS1002EJ0200



NP35N055YUK

55 V - 35 A - N-channel Power MOS FET

Application: Automotive

Rev.2.00

May 24, 2018

Description

The NP35N055YUK is N-channel MOS Field Effect Transistors designed for high current switching applications.

Features

- Super low on-state resistance $R_{DS(on)} = 6.7 \ m\Omega \ MAX. \ (V_{GS} = 10 \ V, \ I_D = 18 \ A)$
- Non logic level drive type
- Designed for automotive application and AEC-Q101 qualified

Ordering Information

Part No.	Lead Plating	Pac	Package	
NP35N055YUK-E1-AY *1	Pure Sn (Tin)	Tape 2500 p/reel	Taping (E1 type)	8-pin HSON
NP35N055YUK-E2-AY *1			Taping (E2 type)	

Note: *1 Pb-free (This product does not contain Pb in the external electrode)

Absolute Maximum Ratings $(T_A = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to Source Voltage (V _{GS} = 0 V)	V _{DSS}	55	V
Gate to Source Voltage (V _{DS} = 0 V)	V _{GSS}	±20	V
Drain Current (DC) (T _C = 25°C)	I _{D(DC)}	±35	Α
Drain Current (pulse) *1,4	I _{D(pulse)}	±140	А
Total Power Dissipation (T _C = 25°C)	P _{T1}	97	W
Total Power Dissipation (T _A = 25°C) *2	P _{T2}	1.0	W
Channel Temperature	T _{ch}	175	°C
Storage Temperature	T _{stg}	–55 to +175	°C
Repetitive Avalanche Current *3, 4	I _{AR}	24	Α
Repetitive Avalanche Energy *3, 4	E _{AR}	58	mJ

Thermal Resistance

Notes: *1 $\,$ Tc = 25°C, $P_W \leq$ 10 $\mu s, \,$ Duty $Cycle \leq$ 1%

*2 Mounted on glass epoxy substrate of 40 mm \times 40 mm \times 1.6 mmt with 4% Copper area (35 μ m)

*3 R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0 V

*4. Not subject of production test. Verified by design/characterization.

Electrical Characteristics (T_A = 25°C)

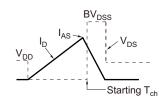
Item	Symbol	MIN.	TYP.	MAX.	Unit	Test Conditions	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	V _{DS} = 55 V, V _{GS} = 0 V	
Gate Leakage Current	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	
Gate to Source Threshold Voltage	$V_{GS(th)}$	2.0	3.0	4.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Forward Transfer Admittance *1	y _{fs}	18	36	_	S	$V_{DS} = 5 \text{ V}, I_{D} = 18 \text{ A}$	
Drain to Source On-state Resistance *1	R _{DS(on)}	_	5.3	6.7	mΩ	$V_{GS} = 10 \text{ V}, I_{D} = 18 \text{ A}$	
Input Capacitance *2	C _{iss}	_	2240	3360	pF	V _{DS} = 25 V	
Output Capacitance *2	Coss	_	230	350	pF	$V_{GS} = 0 V$	
Reverse Transfer Capacitance *2	C _{rss}	_	95	180	pF	f = 1 MHz	
Turn-on Delay Time *2	t _{d(on)}	_	19	38	ns	$V_{DD} = 28 \text{ V}, I_D = 18 \text{ A}$	
Rise Time *2	t _r	_	9	22	ns	V _{GS} = 10 V	
Turn-off Delay Time *2	t _{d(off)}	_	47	94	ns	$R_G = 0 \Omega$	
Fall Time *2	t _f	_	4	10	ns		
Total Gate Charge *2	Q_{G}	_	38	57	nC	V _{DD} = 44 V	
Gate to Source Charge	Q _{GS}	_	10	_	nC	V _{GS} = 10 V	
Gate to Drain Charge	Q _{GD}	_	10	_	nC	I _D = 35 A	
Body Diode Forward Voltage *1	V _{F(S-D)}		0.9	1.5	V	I _F = 35 A, V _{GS} = 0 V	
Reverse Recovery Time	t _{rr}	_	35	_	ns	I _F = 35 A, V _{GS} = 0 V	
Reverse Recovery Charge	Qrr		41		nC	di/dt = 100 A/μs	

Note: *1 Pulsed test

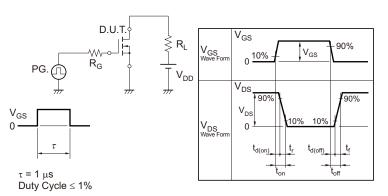
Note: *2 Not subject of production test. Verified by design/characterization.

TEST CIRCUIT 1 AVALANCHE CAPABILITY

$V_{GS} = 20 \rightarrow 0 \text{ V}$



TEST CIRCUIT 2 SWITCHING TIME

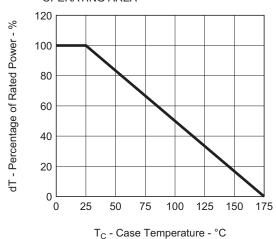


TEST CIRCUIT 3 GATE CHARGE

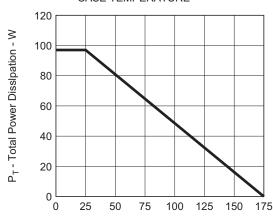
$$\begin{array}{c|c} D.U.T. \\ I_G = 2 \text{ mA} \\ \hline \end{array} \begin{array}{c} PG. \\ \hline \end{array} \begin{array}{c} S \\ S \\ \end{array} \begin{array}{c} S \\ S \\ \end{array} \begin{array}{c} O.U.T. \\ \hline \end{array} \begin{array}{c} O.U.T. \\ \end{array} \begin{array}{c} O.U.T. \\$$

Typical Characteristics (T_A = 25°C)

DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA

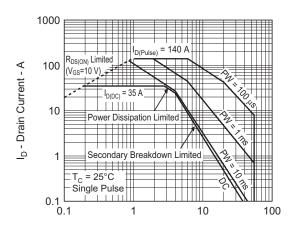


TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



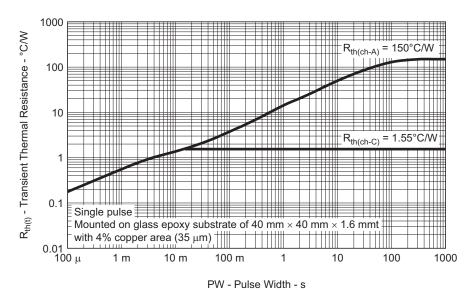
T_C - Case Temperature - °C

FORWARD BIAS SAFE OPERATING AREA



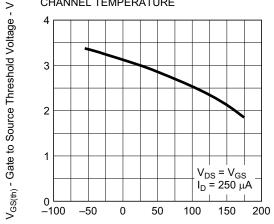
 V_{DS} - Drain to Source Voltage - V

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



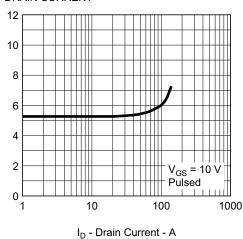
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE 160 140 I_D - Drain Current - A 120 100 80 60 40 V_{GS} = 10 V 20 Pulsed 0 0 0.2 0.4 0.6 8.0 1.0 1.2 V_{DS} - Drain to Source Voltage - V



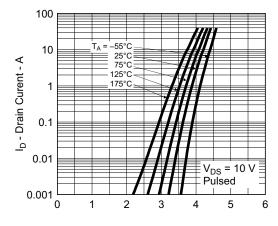


T_{ch} - Channel Temperature - °C

DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

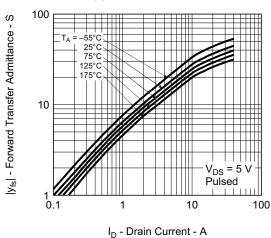


FORWARD TRANSFER CHARACTERISTICS

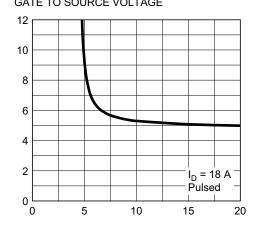


V_{GS} - Gate to Source Voltage - V

FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



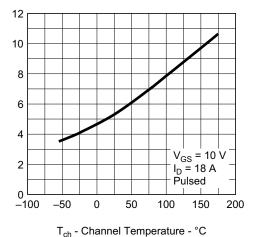
 V_{GS} - Gate to Source Voltage - V

 $R_{DS(on)}$ - Drain to Source On-State Resistance - $m\Omega$

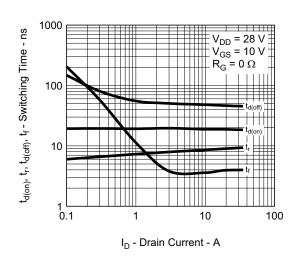
 $R_{DS(on)}$ - Drain to Source On-State Resistance - $m\Omega$

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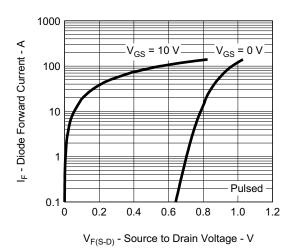
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



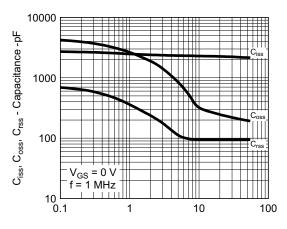
SWITCHING CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE

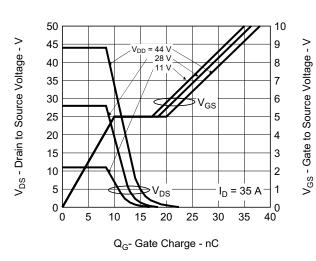


CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

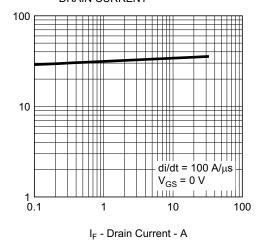


V_{DS} - Drain to Source Voltage - V

DYNAMIC INPUT/OUTPUT CHARACTERISTICS



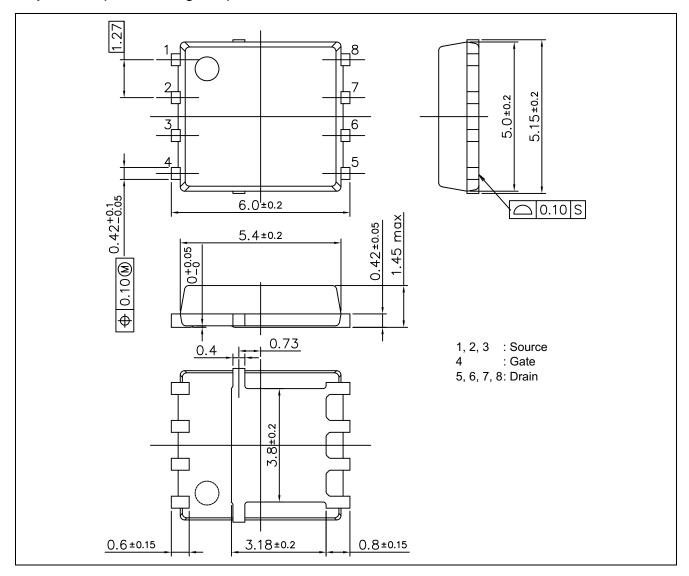
REVERSE RECOVERY TIME vs. DRAIN CURRENT



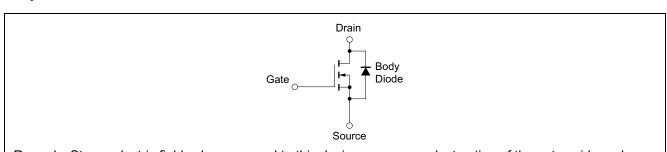
t_{rr} - Reverse Recovery Time - ns

Package Drawing (Unit: mm)

8-pin HSON (Mass: 0.128 g TYP.)



Equivalent Circuit



Remark: Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

Revision History

NP35N055YUK Data Sheet

		Description		
Rev.	Date	Page	Summary	
1.00	Feb 08, 2013	_	First Edition Issued	
2.00	May 24 ,2018	1	Note 4 was added	
		2	Note 2 was added	

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